

VALER12.001APC

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Taran, Aleksander Ivanovich

Appl. No. : Unknown

Filed : Herewith

For : MULTILAYERED CONNECTION
PLATE

Examiner : Unknown

Group Art Unit Unknown

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April 27, 2001
(Date)

John M. Carson, Reg. No. 34,303

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Please enter the following amendment to the above-referenced application before examination of the application on the merits.

IN THE CLAIMS:

Please cancel Claims 1-8.

Please add the following claims:

9. (New) A multilayered connection plate, comprising:
- a plurality of layers of a dielectric material having conductive paths on their surfaces, the layers being connection layers; and
 - a plurality of contact nodes in the form of metallized contacts mutually aligned and interconnected electrically and mechanically by a conductive binding material, wherein the contact nodes are made in the form of joints between the contacts, some of which contacts are contact pads coupled with conductive paths of the underlying connection layer, and other contacts aligned with the contact pads are made in the form of

[illegible]